COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 002

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: ISE4037</th>
<th>REV: E3</th>
<th>SUN REV: Not In VersionControl</th>
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<td>TID #: TIDA-00485</td>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 6/16/2015 2:03:53 PM</td>
<td></td>
<td>TEXAS INSTRUMENTS</td>
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